

# SDN520C

N-Ch: 4.5 A, 20 V,  $R_{DS(ON)}$  58 m $\Omega$

P-Ch: -4.5 A, -20 V,  $R_{DS(ON)}$  112 m $\Omega$

N & P-Channel Enhancement Mode MOSFET

**RoHS Compliant Product**

A suffix of “-C” specifies halogen and lead-free

## DESCRIPTION

These miniature surface mount MOSFETs utilize a high cell Density trench process to provide low  $R_{DS(ON)}$  and to assure minimal power loss and heat dissipation.

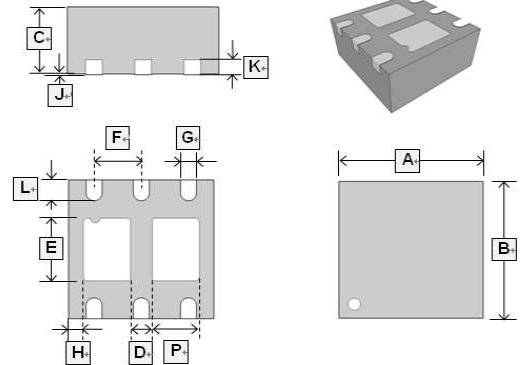
## FEATURES

- Low  $R_{DS(ON)}$  provides higher efficiency and extends battery life.
- Low thermal impedance copper leadframe DFN2X2\_6L saves board space.
- Fast switching speed.
- High performance trench technology.

## APPLICATION

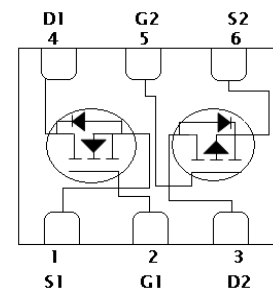
DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

### DFN2x2-6L



REF.	Millimeter			REF.	Millimeter		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	2.00 BSC.			G	0.23	0.30	0.38
B	2.00 BSC.			H	0.65BSC		
C	0.675	0.75	0.80	J	0	-	0.05
D	0.25	0.30	0.35	K	0.15	0.20	0.25
E	0.81	0.86	0.91	L	0.25	0.30	0.35
F	0.65BSC			P	0.60	0.65	0.70

### TOP VIEW



## ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Ratings		Unit	
		N-Channel	P-Channel		
Drain-Source Voltage	$V_{DS}$	20	-20	V	
Gate-Source Voltage	$V_{GS}$	$\pm 8$	$\pm 8$	V	
Continuous Drain Current <sup>1</sup>	$I_D$	$T_A=25^\circ\text{C}$	4.5	-4.5	A
		$T_A=70^\circ\text{C}$	4.5	-4.5	
Pulsed Drain Current <sup>2</sup>	$I_{DM}$	8	-8	A	
Continuous Source Current (Diode Conduction) <sup>1</sup>	$I_S$	4.5	-4.5	A	
Power Dissipation <sup>1</sup>	$P_D$	$T_A=25^\circ\text{C}$	6.5		W
		$T_A=70^\circ\text{C}$	5		
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 ~ +150		$^\circ\text{C}$	
Thermal Resistance Rating					
Parameter	Symbol	Typ	Max	Unit	
Maximum Junction to Ambient <sup>1</sup>	$R_{\theta JA}$	$t \leq 5 \text{ sec}$	52	65	$^\circ\text{C} / \text{W}$
		Steady State	12.5	16	

Notes:

1. Surface Mounted on 1" x 1" FR4 Board.
2. Pulse width limited by maximum junction temperature.

**ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions		
Gate-Threshold Voltage	N-Ch	1	-	-	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA		
	P-Ch	-1	-	-		V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = -250uA		
Gate-Body Leakage Current	N-Ch	-	-	100	uA	V <sub>DS</sub> = 0 , V <sub>GS</sub> = 8 V		
	P-Ch	-	-	-100		V <sub>DS</sub> = 0 , V <sub>GS</sub> = -8 V		
Zero Gate Voltage Drain Current	N-Ch	-	-	1	uA	V <sub>DS</sub> =16 V, V <sub>GS</sub> =0		
	P-Ch	-	-	-1		V <sub>DS</sub> =-16V, V <sub>GS</sub> =0		
	N-Ch	-	-	10		V <sub>DS</sub> =16V, V <sub>GS</sub> =0 , T <sub>J</sub> =55°C		
	P-Ch	-	-	-10		V <sub>DS</sub> = -16V, V <sub>GS</sub> =0 , T <sub>J</sub> =55°C		
On-State Drain Current <sup>1</sup>	N-Ch	5	-	-	A	V <sub>DS</sub> = 5V, V <sub>GS</sub> =4.5 V		
	P-Ch	-5	-	-		V <sub>DS</sub> = -5V, V <sub>GS</sub> = -4.5 V		
Drain-Source On-Resistance <sup>1</sup>	N-Ch	-	-	58	mΩ	V <sub>GS</sub> =4.5V, I <sub>D</sub> = 1A		
	P-Ch	-	-	112		V <sub>GS</sub> =-4.5V, I <sub>D</sub> = 1A		
	N-Ch	-	-	82		V <sub>GS</sub> =2.5V, I <sub>D</sub> = A		
	P-Ch	-	-	172		V <sub>GS</sub> =-2.5V, I <sub>D</sub> = -1A		
Forward Transconductance <sup>1</sup>	N-Ch	-	10	-	S	V <sub>DS</sub> = 5V, I <sub>D</sub> = 1A		
	P-Ch	-	5	-		V <sub>DS</sub> = -5V, I <sub>D</sub> = 11A		
Diode Forward Voltage <sup>1</sup>	N-Ch	-	0.80	-	S	I <sub>S</sub> = 1.05A, V <sub>GS</sub> = 0		
	P-Ch	-	-0.83	-		I <sub>S</sub> = -1.05A, V <sub>GS</sub> = 0		
<b>Dynamic <sup>2</sup></b>								
Total Gate Charge	N-Ch	Q <sub>g</sub>	-	7.5	-	nC	N-Channel V <sub>DS</sub> =15V, V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 2.7A	
	P-Ch		-	3.8	-			
Gate-Source Charge	N-Ch	Q <sub>gs</sub>	-	0.6	-			P-Channel V <sub>DS</sub> = -15V, V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -3.1A
	P-Ch		-	0.6	-			
Gate-Drain Charge	N-Ch	Q <sub>gd</sub>	-	1.0	-		nS	N-Channel V <sub>DD</sub> = 15V, R <sub>GEN</sub> = 15Ω, V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 1A
	P-Ch		-	1.5	-			
Turn-on Delay Time	N-Ch	T <sub>d(on)</sub>	-	5	-	P-Channel V <sub>DD</sub> = -15V, R <sub>GEN</sub> = 15Ω V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -1A		
	P-Ch		-	5	-			
Rise Time	N-Ch	T <sub>r</sub>	-	12	-			
	P-Ch		-	15	-			
Turn-off Delay Time	N-Ch	T <sub>d(off)</sub>	-	13	-			
	P-Ch		-	20	-			
Fall Time	N-Ch	T <sub>f</sub>	-	7	-			
	P-Ch		-	20	-			

Notes:

1. Pulse test: PW ≤ 300us duty cycle ≤ 2%.
2. Guaranteed by design, not subject to production testing.